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J1044 U.S. PTO

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Attorney Docket No. 2511

JC971 U.S. PTO
09/042278
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TRANSMITTAL LETTER

Bellevue, Washington 98007
April 24, 2001

TO THE ASSISTANT COMMISSIONER FOR PATENTS:

Transmitted herewith for filing by Express Mail is the patent application of Michael J. Grier, Sanjay G. Shenoy, RoseMarie FitzSimons, David D'Souza, Srivatsan Parthasarathy, Micheal Dunn, Alan Shi

Title: **Configurations for Binding Software Assemblies to Application Programs**

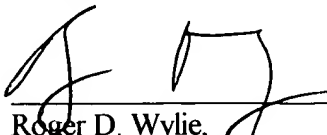
1. An application consisting of 67 pages of cover sheet, specification, claims and abstract.
2. Fourteen (14) sheets of formal drawings are attached.
3. Please publish the application in the name of Microsoft Corporation
4. The following additional documents are enclosed: Certificate of Express Mail.

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Respectfully submitted,

MICHALIK & WYLIE^{PLLC}



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Registration No. 36,974

In re Application of GRIER et al.
Attorney Docket No. 2511

CERTIFICATE OF MAILING BY "EXPRESS MAIL"

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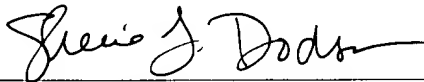
I hereby certify that the following documents:

New Patent Application (claiming priority to United States Provisional Patent Application Serial No. 60/199,227) in the name of Michael J. Grier, Sanjay G. Shenoy, RoseMarie FitzSimons, David D'Souza, Srivatsan Parthasarathy, Micheal Dunn, Alan Shi for **"Configurations for Binding Software Assemblies to Application Programs,"** including Transmittal Sheet and 1 Page Cover Sheet, 55 Pages Specification, 10 Pages Claims, 1 Page Abstract, 14 sheets of Formal Drawings,

are being deposited with the United States Postal Service "Express Mail Post Office To Addressee" Service under 37 C.F.R. 1.10 on the date indicated above and is addressed to: Assistant Commissioner for Patents, Box Patent Application, Washington, D.C. 20231.

Sherie L. Dodson

(Typed or printed name of person mailing paper or fee)



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